

SPECIFICATION

COMMERCIALY AVAILABLE

CERAMIC BP
PART NUMBER: CF-07511005
RoHS

ISSUED / REVISION	ENGINEER APPROVED	DOCUMENT CHECKED	DRAFTSMAN	DOCUMENT CHECKED
8/28/08**				
12/30/11 DS				

FILTRONETICS Inc

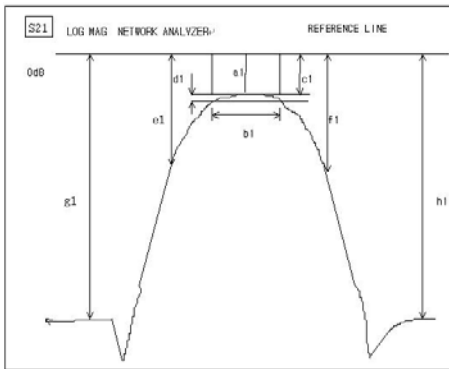
1. PART NUMBER:

PART NO	CF-07511005
PACKAGING	PLASTIC TRAY

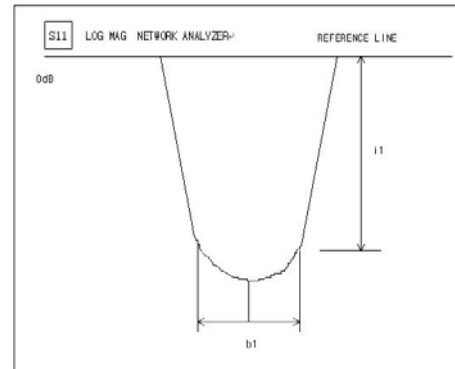
2. SPECIFICATION:

NO	ITEMS	Ref.	SPECIFICATION
1	Center Frequency (Fo)	-	751 MHz
2	Pass Band Width(=PB)	-	Fo +/- 50 MHz
3	Insertion Loss in PB	-	2.0 dB Max
4	- 1.0 dB Band Width	-	Fo +/-50MHz Min
5	Attenuation	At Fo - 165MHz	55dB Min
		At Fo + 165MHz	50dB Min
6	Return Loss in PB	-	14 dB Min
7	Impedance	-	50 Ω
8	Maximum Input Power	-	1 W (+30dBm)
9	Group Delay Variation in PB	-	11ns Max
10	Operating Temperature Range	-	-35°C - +75°C

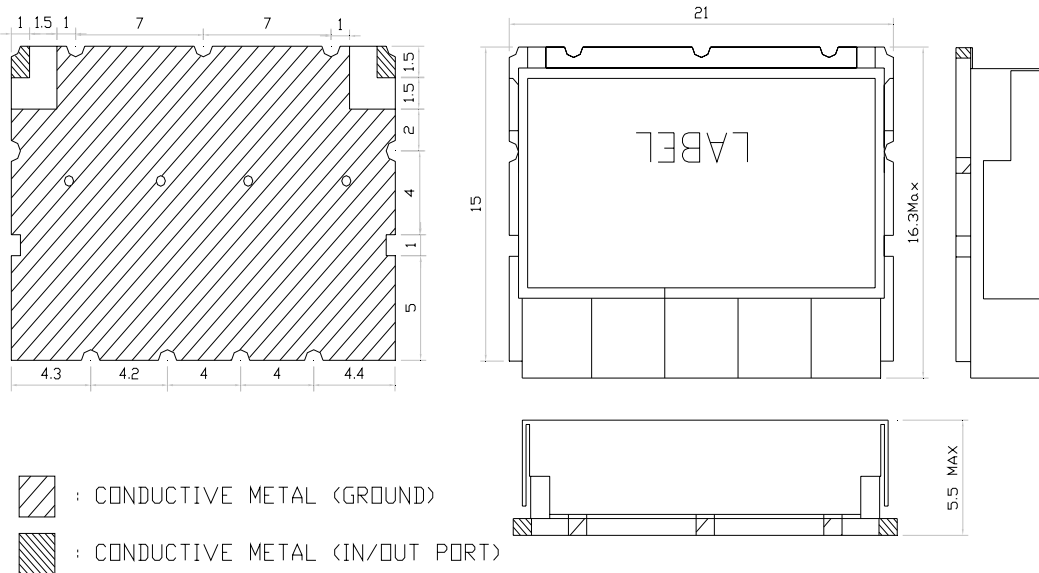
S21 LOG MAG NETWORK ANALYZER



S11 LOG MAG NETWORK ANALYZER



3. DIMENSIONS



MATERIAL SPECIFICATION

1. PCB
 - 1) MATERIAL: FR4
 - 2) TERMINALS: Au PLATED
2. METAL CASE
 - 1) MATERIAL: Sn OR Ni PLATED
3. RESONATOR
 - 1) COATING MATERIAL: Ag
4. ROHS Compliant

MARKING

Part No: CF-07511005
 Filtronetics, Inc
 Date Code

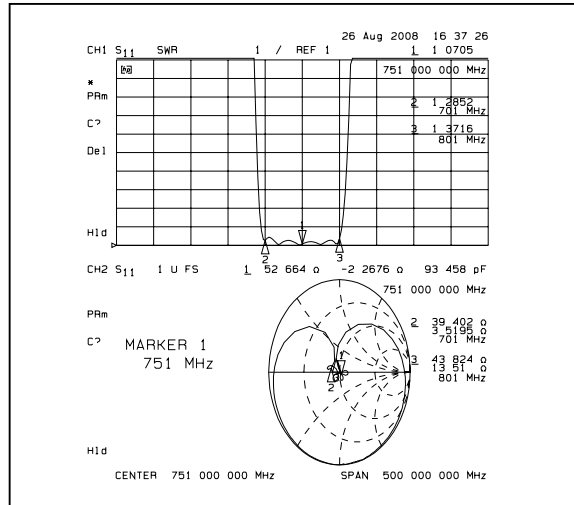
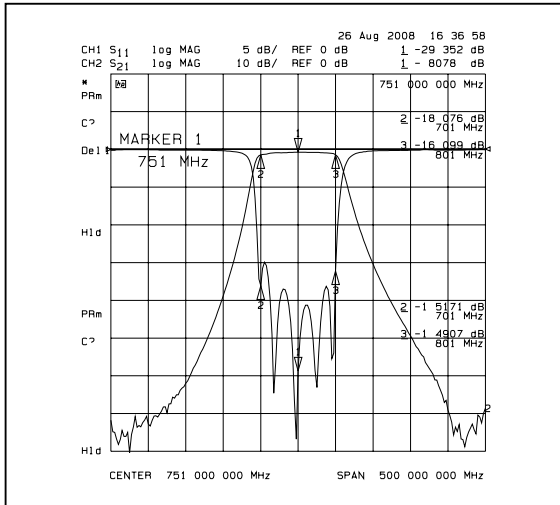
UNIT: MM
 TOLERANCE: +/-0.5MM
 IN/OUT LAND : +/-0.3MM

● CAUTIONS:

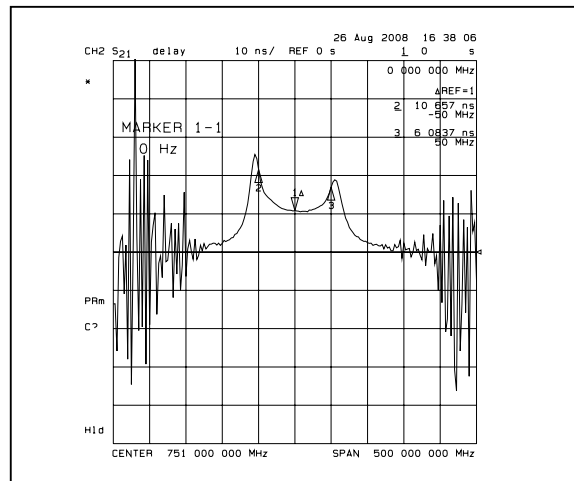
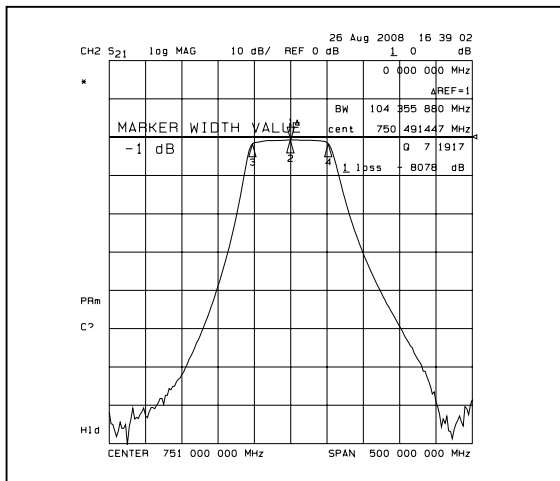
1. When handling products, be careful not to damage the outer-electrode.
2. When handling products be careful not to touch the outer-electrode with bare hands or solderability is reduced.
3. Do not apply excessive pressure or shock to product in handling or in transportation or damage to the ceramic filters may result.

4. GRAPHS:

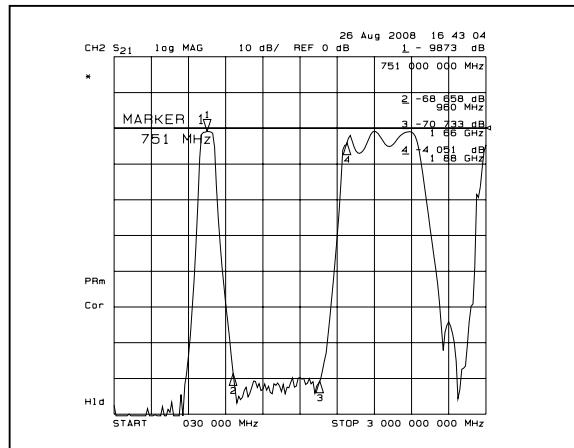
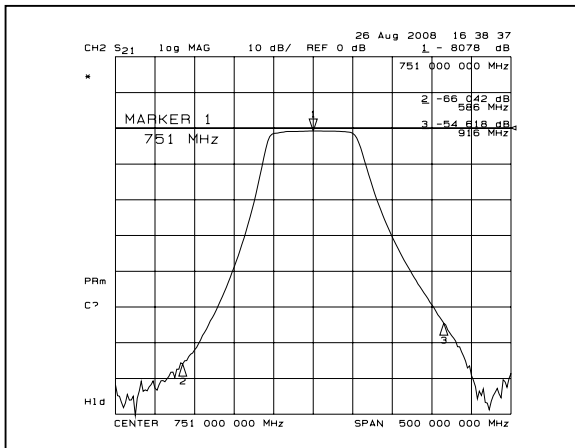
S21 vs S11(INsertion Loss, RETURN LOSS, V.S.W.R, SMITH CHART)



S21 (1dB BAND WIDTH, GROUP DELAY)



S21 (ATTENUATION)



6. DEFINITIONS:

TERMS	DESCRIPTION	SPECIFICATION
Center Frequency	The midpoint of through band pass filter pass band, normally expressed as the arithmetic mean of the -3db point. Also called f_0 .	3. SPECIFICATION
Pass Band Width	The width of the pass band of a filter referenced to the minimum insertion loss point in the pass band. The pass band of a filter is stated as -1.0dB bandwidth.	
Insertion Loss	The loss of the filter, in db, measured at center frequency relative to a through line (0 dB).	
Attenuation	Reduction of RF power through a filter measured in dB, at desired band and referenced to 0 dB. (Filter to be removed from circuit)	
Pass Band Ripple	Variations in loss in the pass band of the filter, superimposed upon the fundamental shape of the pass band.	
V.S.W.R in Pass Band	The ratio of the maximum value of a standing wave to its minimum value, related to the return loss in pass band.	

7. RELIABILITY TEST AND CONDITIONS:

ITEM	TEST CONDITIONS	REQUIREMENTS
Resistance to solder heat	Preheat temperature : 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 260 +/- 10°C Dipping time: 10 +/- 0.5 sec	No damage such as cracks should be caused in chip element.
Solderability	Preheat temperature: 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 235 +/- 5°C Dipping time: 5 +/- 1 sec	More than 80% of the terminal electrode shall be covered with new solder
Heat resistance (High-temperature Load)	Temperature: 85 +/- 2°C Applied voltage: Rated voltage Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Thermal shock (Temperature cycle)	Conditions for 1 cycle Step 1: + 85°C 15 min Step 2 : - 30°C 15 min Number of cycle: 10	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Humidity Resistance	Temperature: 40 +/- 2°C Humidity: 90 to 95% RH Duration: 96 +/- 5 hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Vibration	Frequency: 10 ~ 50 Hz Amplitude: 1.52 mm (0.060 inches) Direction: X, Y and Z Time: each 30 min for all directions	No mechanical damage. After test, the device shall satisfy the specification in section 3.